

MAHARASHTRA STATE BOARD OF TECHNICAL EDUCATION, MUMBAI

TEACHING AND EXAMINATION SCHEME FOR POST S.S.C. DIPLOMA COURSES

COURSE NAME: MECHANICAL ENGINEERING GROUP

COURSE CODE: ME/PG/PT/MH/MI

DURATION OF COURSE: 6 SEMESTERS for ME/PG/PT/AE (8 SEMESTERS for MH/MI) WITH EFFECT FROM 2012-13

SEMESTER: THIRD

DURATION: 16 WEEKS

PATTERN: FULL TIME - SEMESTER

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				TE	ACHI	NG			EX	AMINA	TION S	СНЕМЕ	2			
SR. NO	SUBJECT TITLE	Abbrev iation	SUB CODE	S	CHEM	E	PAPER	TH	(1)	PR	(4)	OR	(8)	TW	(9)	SW (17300)
110		lation	CODE	TH	TU	PR	HRS.	Max	Min	Max	Min	Max	Min	Max	Min	(17500)
1	Applied Mathematics \$	AMS	17301	03			03	100	40							
2	Basic Electronics & Mechatronics	BEM	17302	04		02	03	100	40					25@	10	
3	Mechanical Engineering Materials	MEM	17303	04			03	100	40							
4	Strength of Materials β	SOM	17304	03		02	03	100	40					25@	10	50
5	Mechanical Engineering Drawing β	MED	17305	03		04	04	100	40			25#	10	50@	20	
6	Computer Aided Drafting β	CAD	17016	01		04				50#	20	1		25@	10	
7	Professional Practices-I β	PPO	17017			03					1	1		50@	20	
		•	TOTAL	18		15		500		50		25		175		50

Student Contact Hours Per Week: 33 Hrs.

THEORY AND PRACTICAL PERIODS OF 60 MINUTES EACH.

Total Marks: 800

@ - Internal Assessment, # - External Assessment,

No Theory Examination, \$ - Common to all branches, β - Common to AE / PS / FE

SCHEME · C

Abbreviations: TH-Theory, TU-Tutorial, PR-Practical, OR-Oral, TW-Term Work, SW-Sessional Work

- Conduct two class tests each of 25 marks for each theory subject. Sum of the total test marks of all subjects is to be converted out of 50 marks as sessional work (SW).
- > Progressive evaluation is to be done by subject teacher as per the prevailing curriculum implementation and assessment norms.
- ➤ Code number for TH, PR, OR, TW are to be given as suffix 1, 4, 8, 9 respectively to the subject code.
- > For CAD software subject MSBTE decide the contents of the practical every year.

Course Name: All Branches of Diploma in Engineering & Technology

Course Code: AE/CE/CH/CM/CO/CR/CS/CW/DE/EE/EP/IF/EJ/EN/ET/EV/EX/IC/IE/IS/

ME/MU/PG/PT/PS/CD/CV/ED/EI/FE/IU/MH/MI

Semester: Third

Subject Title: Applied Mathematics

Subject Code: 17301

Teaching and Examination Scheme:

Teaching Scheme					Examinati	on Scheme		
TH	TU	PR	PAPER HRS	TH	PR	OR	TW	TOTAL
03			03	100				100

NOTE:

> Two tests each of 25 marks to be conducted as per the schedule given by MSBTE.

> Total of tests marks for all theory subjects are to be converted out of 50 and to be entered in mark sheet under the head Sessional Work. (SW)

Rationale:

Applied mathematics is designed for its applications in engineering and technology. It includes the topics integration, differential equation, probability distribution. The connection between applied mathematics and its applications in real life can be understood and appreciated.

Derivatives are useful to find slope of the curve, maxima and minima of function, radius of curvature. Integral calculus helps in finding the area. In analog to digital converter and modulation system integration is important. Differential equation is used in finding curve. Probability is used in Metrology and quality control.

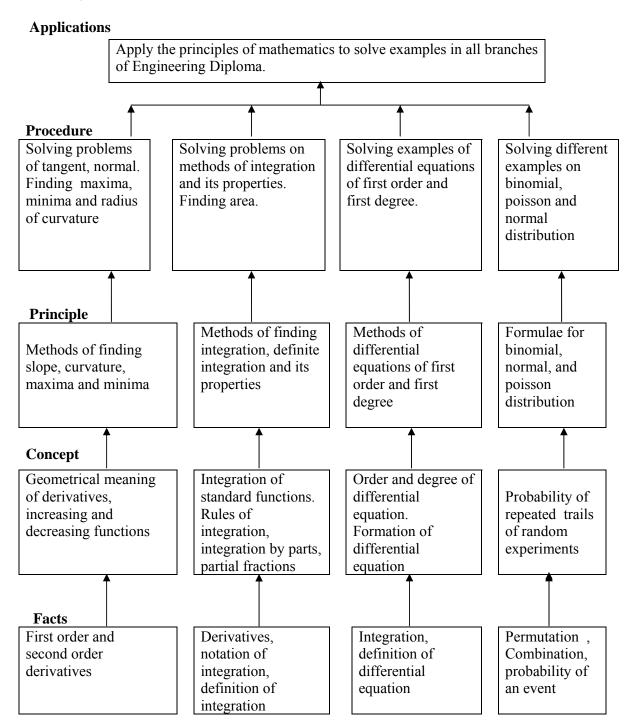
The fundamentals of this topic are directly useful in understanding engineering applications in various fields.

General Objectives:

Students will be able to:

- 1. Apply derivatives to find slope, maxima, minima and radius of curvature.
- 2. Apply integral calculus to solve different engineering problems.
- 3. Apply the concept of integration for finding area.
- 4. Apply differential equation for solving problems in different engineering fields.
- 5. Apply the knowledge of probability to solve the examples related to the production process.

Learning Structure:



Theory:

Specific objectives: Find slope, curvature, maximum and minimum value of functions related to different engineering applications. • Examples for finding slope, equations of tangent and normal to the curve • Maxima and minima. • Radius of curvature. Topic-2 Integral Calculus 2.1 Integration Specific objectives: Integrate function using different method. • Definition of integration as anti derivative, rules of integration. • Integration by partial fractions • Methods of integration Integration by partial fractions. OB Specific objectives: Find area. • Area under a curve. • Area between two curves. Topic 3 - Differential Equation. 3.1 Differential Equation. Specific objectives:	Topic and Contents	Hours	Marks
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for following types Variable separable form, Equation reducible to variable separable form. Linear differential equation. Homogeneous differential equation.		10	20
Variable separable form, Equation reducible to variable separable form. Linear differential equation. Homogeneous differential equation.		10	20
Equation reducible to variable separable form. Linear differential equation. Homogeneous differential equation.	O 71		
Linear differential equation. Homogeneous differential equation.			
Homogeneous differential equation.	•		

Topic 4 - Probability		
4.1 Probability		
Specific objectives: 08		
 Solve different engineering problems related to probability process. Definition of random experiment, sample space, event, occurrence of event and types of event (impossible, mutually exclusive, exhaustive, equally likely) Definition of probability, addition and multiplication theorems of probability. 	02	20
 4.2 Probability Distribution Binomial distribution Poisson's Distribution Normal distribution 	04	
Total	48	100

Learning Resources: 1) Books:

Sr. No	Title	Authors	Publication
1	Mathematic for Polytechnic	S. P. Deshpande	Pune Vidyarthi Girha Prakashan' Pune
2	Calculus : Single Variable	Robert. T. Smith	Tata McGraw Hill
3	Higher Engineering mathematics	B. V Ramana	Tata McGraw Hill
4	Higher Engineering mathematics	H. K. Dass	S .Chand Publication
5	Higher Engineering Mathematics	B. S. Grewal	Khanna Publication, New Delhi
6	Applied Mathematics	P. N. Wartikar	Pune Vidyarthi Griha Prakashan, pune

2) Websites:

i) www.khan academy

w.e.f Academic Year 2012-13 'G' Scheme

Course Name: Mechanical Engineering Group

Course Code: ME/PG/PT/MH/MI

Semester : Third

Subject Title: Basic Electronics & Mechatronics

Subject Code: 17302

Teaching and Examination Scheme:

Teaching Scheme					Examinati	on Scheme		
TH	TU	PR	PAPER HRS	TH	PR	OR	TW	TOTAL
04		02	03	100			25@	125

NOTE:

> Two tests each of 25 marks to be conducted as per the schedule given by MSBTE.

> Total of tests marks for all theory subjects are to be converted out of 50 and to be entered in mark sheet under the head Sessional Work. (SW)

Rationale:

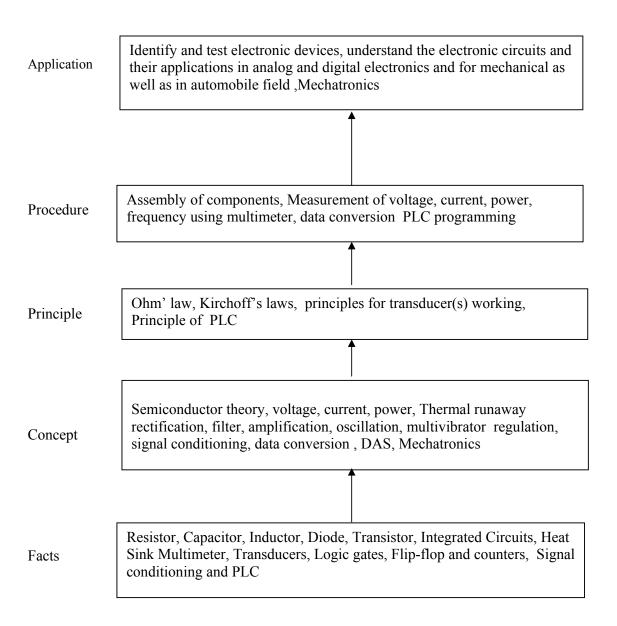
This subject is classified under core technology group and forms an important course of mechanical branch of engineering. The course envisages identification and testing of components, their principles of working and applications of various electronic devices, signal conditioning and processing. This subject introduces the concepts of mechatronics and PLC. This subject is prerequisite for the subject mechanical measurement and control as well as for mechatronics.

General Objectives:

The students will be able to: -

- 1. Identify and test different electronic components.
- 2. Use principles of circuit operations and its applications.
- 3. Distinguish various elements in analogue and digital electronics.
- 4. Understand applications of electronics in mechanical field for measurement and control.
- 5. Understand working of different types of transducers and their applications.
- 6. Understand concept of mechatronics and PLC.

Learning Structure:



Theory

Topic and Contents	Hours	Marks
1: Solid-State Devices and Diode Circuits		
Specific objectives		
Students will be able to		
Draw energy band diagram and compare various types of materials		
➤ Draw symbols ,state working principle and list out ,applications of		
electronics devices in electronics and mechanical field		
> Sketch circuit diagram, state working with waveform for rectifier		
circuits		
➤ Sketch block diagram and state functions of various blocks of regulated		
power supply		
Content		
1.1 Fundamentals of solid state Devices— 10 Marks		
Material classification conductors, semiconductors and insulators, Energy		
band diagram intrinsic and extrinsic semiconductors	10	18
Solid state Devices schematic symbols, working principle and		
applications of Diode, Zener diode, BJT, FET,UJT, Photo-devices- LDR,		
Photo diode, Photo-transistor, LED, 7 segment display opto-coupler, LCD		
type and operation [No constructional details are expected]		
1.2 Diode Circuits : 04 Marks		
Rectifier circuits Circuit diagram, working principle and waveforms for		
Half wave, Full wave-and Bridge rectifier, comparison w. r. t efficiency,		
PIV, ripple factor and applications Filters circuits C, inverted L and CLC		
filter circuit diagram and operation of these filters.		
1.3 Regulated power supply 04Marks		
Concept of load regulation, line regulation, block diagram and functions of		
each block [Note Mathematical calculations is not expected for any		
subtopic]		
2: Transistor Circuits		
Specific objectives		
Students will be able to		
Explain working of BJT, Biasing of BJT and concept of thermal		
runaway		
Compare CB, CC and CE configuration		
Write operation of single stage amplifier.		
> Draw circuits of RC, direct and transformer coupled amplifier and		
compare their performance	08	14
Content:		
2.1 Tansistor 06 Marks		
Working of NPN and PNP transistor, Configurations CB., CC and CE,		
Biasing circuits, concept of thermal runway, construction and use of heat		
sink [No need of design and mathematical analysis]		
2.2 BJT Circuits 08 Marks DIT as an amplifier single stage amplifier Multistage amplifier BC		
BJT as an amplifier single stage amplifier, Multistage amplifier, RC		
coupled, direct coupled and transformer coupled amplifier, their frequency		
response and applications BJT as a switch		
3: Analog Circuits Specific objectives		
Student will be able to		
Explain and draw block diagram of IC 741, circuits of op amp as		
- Explain and draw block diagram of ite 741, circuits of op amp as		

inverting, non-inverting, differential amplifier, adder, substractor, integrator, differentiator, and Instrumentation amplifier > Explain and draw block diagram of IC 555, circuits of timer as BMV, AMV and MMV > State Barkhausen criteria and compare oscillator circuits Content: 3.1 Operational amplifier O8 Marks IC741 Block diagram, pin diagram, specifications, and applications Op amp configurations- Inverting, Non-inverting and differential circuit diagram and operation of these circuits Op amp as adder, substractor , integrator and differentiator Instrumentation amplifier [simple numerical are expected] 3.2 Timers O6 Marks IC 555-Block diagram pin diagram specifications, Concept of multivibrator IC 555 as AMV, BMV, MMV. 3.3 Oscillator Concept of oscillator, Barkhausen criteria Comparison of RC , LC and Crystal oscillator [no any special circuit is expected] 4.1 Digital Circuits Specific objectives Student will be able to > Draw symbol and write truth table of all logic gates , various combinational circuits, sequential circuits > Compare microprocessor and microcontroller Content: 4.1 Logic gates Study of logic gates, symbol, truth table NOT, AND, OR, NAND, NOR, XOR, XNOR 4.2 Combinational Circuits Half and Full adder, substractor, Multiplexer, de multiplexer, decoder and encoder, applications [only block diagram, truth table and simple circuits] 4.3 Sequential Circuits Flip Flops Block diagram of RSJK, Master Slave JK, D and T, Triggering mechanism Application of flip flop Basics of counter, asynchronous counter, Decade counter, Ring counter, Shift register, [only circuit diagram and operation is expected not details of timing diagram] Concept of Microprocessor and microcontroller Applications 5: Transducers and Signal Conditioning Specific objectives Student will be able to > Define, state characteristics and Classify transducers > Draw block diagrams and explain operation of ADC, DAC, AC and DC signal conditioning. > Explain and draw block diagram of single and multi-channel			
Explain and draw block diagram of IC 555, circuits of timer as BMV, AMV and MMV	inverting, non-inverting, differential amplifier, adder, substractor, integrator, differentiator, and Instrumentation amplifier		
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Definition, Classification characteristics of transducer, Active and passive, primary and secondary, Electrical, mechanical optical transducer their examples, selection criteria.			
Active and passive, primary and secondary, Electrical, mechanical optical transducer their examples, selection criteria.			
transducer their examples, selection criteria.			

Total	64	100
programming examples		
applications, Ladder diagrams, Ladder diagram circuits Simple Ladder		
programming, selection of PLC, Concept of Nano PLC, PLC		
Basic PLC structure, principle of PLC, architecture and components, PLC		
6.2 Programmable Logic Controller(PLC) 08 Marks		
condition system (AVCS) [only brief information]		
(FMS), Computer integrated machine (CIM), Robotics, Advance vehicle		
Functional diagram, approach to CNC, flexible manufacturing system		
disadvantages, applications.		
deployment .Introduction to real time mechatronics system, advantages and		
mechatronics design process modeling and simulation, prototyping and		
Concept of mechatronics, basic elements of mechatronics, Overview of	16	18
6.1 Fundamentals of mechatronics 10 Marks		
Content:		
 State working of basic PLC architecture and write simple programs. 		
Robotics,		
> State operation with block diagram of CNC, FMS, AVCS CIM		
 State applications, advantage disadvantages of mechatronics 		
> State features of real time mechatronics		
> State meaning, need and basic concept of mechatronics.		
Student will be able to		
Specific objectives		
DAS - single channel multi-channel, applications Data loggers 6: Mechatronics and PLC		
Signal conditioning need and Block diagram of AC and DC signal conditioning,		
applications]		
Introduction to Data converter ADC and DAC [only principle of operation and		

Practical:

Skills to be developed:

Intellectual Skills:

- 1. Identification and selection of components.
- 2. Interpretation of circuits and signals.
- 3. Understand working of mechatronics systems and PLC

Motor Skills:

- 1. Drawing of circuits.
- 2. Measurement of various parameters using multimeter.
- 3. Testing of components using IC tester.
- 4. Follow standard test procedure.

List of Practical-

- 1. Identify various passive components such as resistors, capacitors, inductors, switches, transformers, breadboard and cables and write their specifications.
- 2. Identify various active electronic components such as diode, BJT, FET, UJT, LED, Photodiode.
- 3. Use of multimeter (analogue and digital) for current, voltage and resistance measurement Testing of various electronics components.
- 4. Measure frequency and voltage using CRO.
- 5. Construct rectifier circuits on breadboard and observe waveforms on CRO
- 6. Measure load regulation of un-regulated power supply and regulated power supply.

- 7. Trace the given RC coupled amplifier and plot frequency response f and determine its bandwidth.
- 8. Construct Op Amp as inverting amplifier and Non Inverting amplifier on breadboard and observe the waveforms on CRO.
- 9. Verify truth tables for logic gates- . NOT, AND, OR, NAND, NOR, XOR, XNOR Testing of an IC using IC tester.
- 10. Assemble a square wave oscillator for 100 Hz using IC 555. (Use as table multivibrator).
- 11. Write simple PLC program and execute on PLC (2 exercises).

[Note: Expected group size for practical no. 1 and 2 is one, for practical no.3 to 10 is 2 and for practical no 11 it may be 4]

Assignments

- Assignments are part of term work.
- Assignment shall include observation of systems from mechatronics point of view. Individual shall prepare report consisting of functional block diagram of the system, specifications of major components and system operation
 - I. Observe and prepare report on mechatronics used in camera system
 - II. Observe and prepare report on mechatronics used in robotic system

(Where ever possible arrange visit to manufacturing unit where mechatronics is used for production purpose and prepare report.)

Note

Teachers are expected to make students familiar with the Data Books and Operation Manuals and also encourage them to visit related websites.

Learning Resources:

Books:

Sr. No.	Author	Title	Publisher, Edition
01	Boylestad	Electronics devices and circuit Theory	Pearson (Tenth edition)
02	Shalivahnan	Electronics Devices and circuits	TMH
03	Baru Vijay	Basic Electronics Engg.	Wiley India Pvt.Ltd (first edition)
04	De Debasnis Ghatak Kamakhya	Basic Electronics	Pearson (First edition)
05	Bolton	Mechatronics	Pearson (Fourth edition)
06	K.P.Ramchandran, G.K.Vijayaraghavan M.S.Balsundarm	Mechatronics (intergrated mechanical electronics systems)	Wiley india pvt.ltd ,(first edition)

Journals - Manufactures catalogues

- IEEE/ASME Transactions on Mechatronics.
- Mechatronics Journal Elsevier

1. IS, BIS and International Codes:

- NF E 01-010 2008 AFNOR (French standard NF E 01-010)
- XP E 01-013 2009 AFNOR (French standard NF E 01-013)

2. Websites:

http://en.wikipedia.org/wiki/Mechatronic

Course Name: Mechanical Engineering Group

Course Code: ME/MH/MI/PG/PT

Semester: Third

Subject Title: Mechanical Engineering Material

Subject Code: 17303

Teaching and Examination Scheme:

Teaching Scheme					Examinati	on Scheme		
TH	TU	PR	PAPER HRS	TH	PR	OR	TW	TOTAL
04			03	100	1			100

NOTE:

- > Two tests each of 25 marks to be conducted as per the schedule given by MSBTE.
- > Total of tests marks for all theory subjects are to be converted out of 50 and to be entered in mark sheet under the head Sessional Work. (SW)

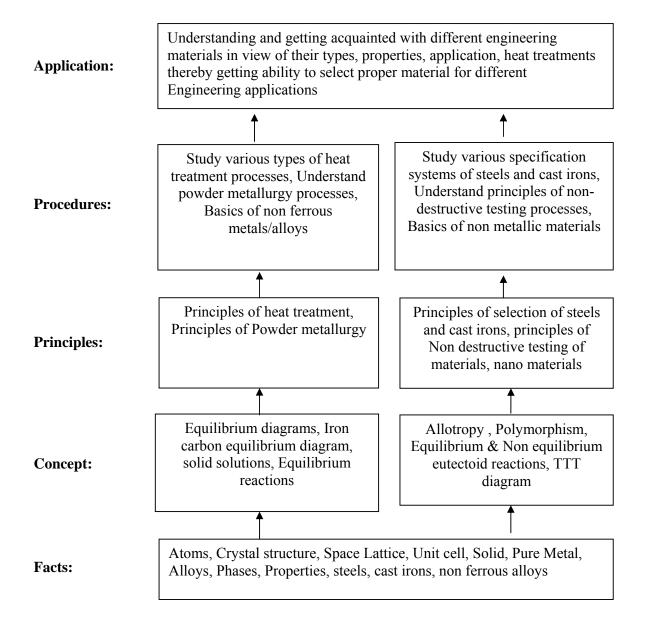
Rationale:

Practical field in engineering involves different materials with varied composition, properties with numerous applications. Diploma engineers should have a good knowledge of composition, properties, and applications of these materials. In order to inculcate the same, this subject is designed. Ferrous & Non ferrous metals and alloys find major applications. Amongst these, steels and cast iron are the main alloys with major applications in engineering practice. Sound knowledge about types, properties, composition and heat treatment of steels and cast irons is absolutely necessary to diploma engineers. He should be able to identify steels and cast irons by their specifications and be able to select them for proper applications. Materials like plastics polymers, are also finding importance in engineering application areas. Powder metallurgy process also finds application in manufacturing of special parts with typical properties. Non destructive testing methods are also extensively used in practice today. Diploma engineers should have basic knowledge of these areas.

General Objectives: Students will be able to

- Understands about basics of engineering materials as regards classification, structure and properties.
- Understand basics of structure property relationships of heat treatments.
- Analyze various types of steels and cast irons along with their specifications.
- Understand about types, composition and field of application of various non ferrous metals and alloys & non metallic materials
- Understand about types, composition and field of application of various Non metallic materials.
- Understand about basic process of powder metallurgy and applications.
- Understand about various Nondestructive testing methods and their applications.

Learning Structure:



Theory Content:

Topic and Contents	Hours	Marks
1. Engineering Materials - Structure and Properties		
Specific Objectives:		
➤ List basic types and crystal structure of materials		
Compare properties of material		
Define steel and cast iron		
Contents:	06	10
1.1 Introduction, Classification of materials as amorphous and crystalline,		
ferrous and non ferrous, Crystal structure Properties of metals Physical		
Properties, Mechanical Properties, unit cell and space lattice, Concept of packing efficiency		
1.2 Introduction to steels and Cast irons as alloys of iron and carbon.		
2. Equilibrium Diagrams		
Specific Objectives:		
Define pure metal, alloy, solid solutions		
Learn different equilibrium Diagrams		
> Draw Iron carbon phase equilibrium diagram, locate fields of steels and		
cast iron on diagram		
Contents:		
2.1 Definitions of phase, pure metal, alloy and solid solutions.		
Types of solid solutions -substitutional and interstitial.		
Solid solubility		
2.2 Solidification of pure metal and	06	16
Alloys:		
 Cooling curves equilibrium diagrams for isomorphous, Eutectic, 		
Eutectoid systems.		
2.3 Iron Carbon Equilibrium diagram		
Study of various phases		
Critical temperatures & significance		
Reactions on Iron carbon equilibrium diagram		
 Introduction of steels and cast irons 		
 Classification of steels on various basis as low, medium, high carbon 		
steels, Hypo, Hyper eutectoid steels		
3. Heat Treatment Of Steels		
Specific Objectives:		
Represent various heat treatment processes on TTT diagram		
 Suggest different heat treatment processes Compare surface heat treatment processes for different steels 		
Contents:16 Marks		
3.1 Transformation in steel on heating under equilibrium conditions	14	24
Transformation of pearlite to austenite	14	∠ '1
Transformation of Pearlie to addedite Transformation of Austenite to Pearlite		
T T T diagrams/isothermal diagram for plain carbon and alloy steels		
3.1.1Annealing:		
Purposes of annealing, Annealing temperature range		
Types of annealing like conventional / full annealing, isothermal		

	, ,	
annealing, spheroidizing annealing, Process Annealing		
3.1.2 Normalizing:		
Purposes of Normalizing, Temperature range,		
Broad applications of Normalizing		
3.1.3 Hardening:		
Purposes of hardening, Hardening temperature range		
 Conventional hardening process, Structure of martensite and properties 		
 quenching mediums, hardening defects. 		
quenening mediums, nardening defects.		
3.1.4 Tempering:		
Purpose of tempering		
Variations of properties of hardened steel with tempering temperatures		
Types of tempering as low, medium and high temperature tempering.		
Martempering, Austempering and patenting processes		
3.2 Surface Heat Treatment 8 Marks		
Need of Surface heat treatment,		
Types of Surface heat treatments like Surface hardening and case		
hardening.		
Surface hardening methods like Flame Hardening , Induction Hardening		
Hardening Case hardening methods like Carburizing Nitriding Cyaniding		
 Case hardening methods like Carburizing, Nitriding, Cyaniding. Steels and Cast Irons: 20 Marks 		
Specific Objectives:		
List different types of steels and cast irons		
 Know manufacturing processes of steels & cast irons 		
Refer to specifications systems of steels and cast irons		
Suggest suitable steels/ cast irons in specifications for particular		
applications.		
Contents:		
4.1 Broad Classification of steels, Plain carbon steels		
Definition, Types & Properties		
 Compositions and applications of low, medium and high carbon steels. 		
compositions and apprecations of low, meatign and mgn earbon seeds.		
4.2 Alloy Steels:	12	20
• Definition & Effects of alloying elements on properties of alloy steels.		
Tool steels: Cold work tool steels, Hot work tool steels, High speed		
steels(HSS), HCHC and OHNS		
Stainless Steels		
Spring Steels		
4.3 Cast Irons: Classification of cast irons and applications.		
Types of cast irons as white, gray, nodular, malleable		
4.4 Specifications of steels and cost Irons		
4.4 Specifications of steels and cast Irons:		
 Bureau Of Indian Standards BIS, AISI / SAE, British Standard B.S. specifications of steels & their equivalents Specifications of cast irons 		
 Selection of appropriate steels and cast irons for engineering 		
- Sciencial of appropriate steers and cast from tot engineering	Įl	

applications like Shafts, axles, Nuts, bolts, Levers, crank shafts, camshafts, Shear blades, agricultural equipments, House hold utensils, machine tool beds, car bodies.		
5. Non ferrous Metals and Alloys 10 Marks		
Specific Objectives: > Select various non ferrous metals/alloys in view of their composition, properties for applications		
Contents: 5.1 Chemical compositions, properties and applications of Copper alloys - brasses, bronzes	08	10
5.2 Aluminium alloysY-alloy, Hindalium, duralium with their composition and applications. Bearing materials like white metals (Sn based), aluminium bronzes. Porous		
self lubricating bearings.		
6. Non Metallic Materials		
Specific Objectives: > Select non metallic materials in view of their composition, properties and applications Contents:		
6.1 Polymeric Materials		
Polymers- types, characteristics,		
 Properties and uses of Thermoplastics, Thermosetting Plastics & Rubbers. 		10
6.2 Thermoplastic and Thermosetting Plastic materials	08	12
 Characteristics and uses of ABS, Acrylics. Nylons and Vinyls, 		
Epoxides, Melamines & Bakelites		
6.3 Rubbers :		
Neoprene, Butadiene, Buna & Silicons – Properties & applications. 6.4 Other Engineering Materials of importance -Properties and applications— Ceramics, glasses, Glass Wool. Introduction to Composite Materials like, Laminated & Fibre reinforced materials Nano materials – nature, properties and applications		
7. Powder Metallurgy & Nondestructive Testing 08 Marks		
Specific Objectives: Know concepts of powder metallurgy process with their applications Compare Different Non destructive testing processes 		
Contents:		
 7.1 Powder Metallurgy : Advantages, limitations and applications of Powder Metallurgy for engineering products. 		
 Brief Description of Process of Powder Metallurgy – Powder making, 	10	08
blending, compacting, sintering, infiltration & impregnation.	10	00
Applications of Powder metallurgy for tungsten carbide tip tools & porous bearing.		
7.2 Non destructive Testing:		
Importance of Non-destructive testing, Difference between Destructive and Nondestructive testing.		
Nondestructive testing methods - Radiography (X-Ray & Gamma		

Ray), Ultrasonic crack detection, Dye penetrant test, Magnaflux test – Comparison & applications		
Total	64	100

Learning Resources:

1. Books:

Sr. No.	Title	Author	Edition	Publisher
01	A Text Book of Material Science and Metallurgy	O. P. Khanna	2005	Dhanpat Rai and Sons
02	Engineering Material and Metallurgy	Shrinivasan	1st	Tata Mc-Graw Hill
03	Material Science And Metallurgy	Dr. V.D. Kodgire	1	Everest Publishing House
04	Engg. Metallurgy	Ramarao & Vyas	1995	Nit -Din Publications,Nagpur
05	Elements of Material Science and Engineering	Lawrence H. Van Vlack	2012	Person Education
06	Introduction to Physical metallurgy	Sidney H. Avner	2006	Tata Mc Graw Hill edition (2nd)
07	Material Science & Engg. Materials	Smith		
08	Physical Metallurgy	Yu Lakhtin		Mir Publication

- 2. CD's PPTs, Video clips on basics of steels, Iron Carbon Diagram, Heat Treatments, Manufacturing of steels, Powder Metallurgy and Non destructive testing
- 3. Charts, Models, Transparencies on basics of steels, Iron Carbon Diagram, Heat Treatments, Manufacturing of steels, Powder Metallurgy and Non destructive testing
- 4. Specifications of steels-standards
 - a) Bureau Of Indian Standards (BIS) Specifications of steels
 - b) British Specifications (B.S.) of steels
 - c) American Iron & Steel Institute (AISI) / Society of Automotive Engineers (SAE) specifications of steels
 - d) Mahindra Ugine Steel Company (MUSCO) steel book
- 5. Web sites of following companies for reference
 - Mukand Iron Ltd
 - Jindal steels
 - Tata steels
 - Rajuri steels
 - Roopam steels
 - TISCO
 - Kalika steels

Course Name: Mechanical Engineering Group
Course Code: ME/PG/PT/AE/MH/MI/FE/PS

Semester: Third

Subject Title: Strength of Materials

Subject Code: 17304

Teaching and Examination Scheme:

Teac	ching Scl	neme	Examination Scheme					
TH	TU	PR	PAPER HRS	TH	PR	OR	TW	TOTAL
03		02	03	100			25@	125

NOTE:

> Two tests each of 25 marks to be conducted as per the schedule given by MSBTE.

> Total of tests marks for all theory subjects are to be converted out of 50 and to be entered in mark sheet under the head Sessional Work (SW).

Rationale:

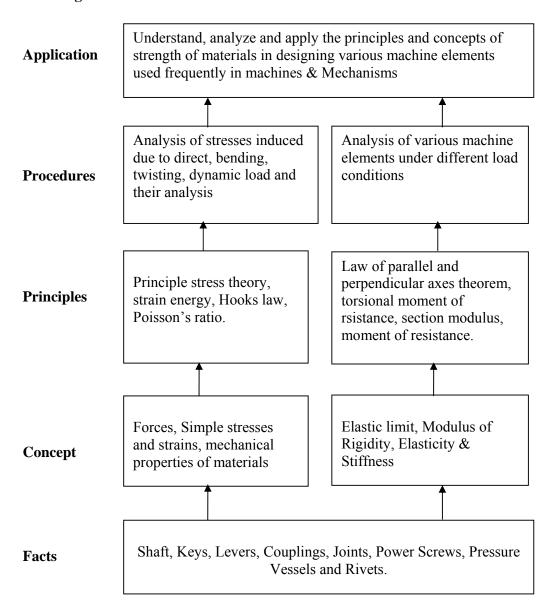
Strength of Material is a core technology subject. It aims at enabling the student to understand & analyze various types of loads, stresses & strains along with main causes of failure of machine parts. The subject is pre-requisite for understanding principles of machine design. Understanding mechanical properties of materials will help in selecting the suitable materials for various engineering applications.

General Objectives:

The Student will be able to:

- 1. Understand the fundamentals of solid mechanics.
- 2. Acquire elementary knowledge of stresses, strains & material properties.
- 3. Understand & analyze the basic principles involved in the behavior of machine parts under load in the context of designing it.
- 4. Understand & analyze the mechanical properties of the various materials.

Learning structure:



Theory

Topic and Contents	Hours	Marks
1. Mechanical Properties of Materials, Simple Stresses & Strains		
	10	16
• Both ends hinged, One end fixed and other free, Both ends fixed, One		
end fixed and other end hinged. (simple numerical only)		
2. Principal stresses and planes. Specific Objectives. ➤ Acquire elementary knowledge of hoop stresses & principal stresses. Contents 2.1 Concept of Principal stresses and Principal planes. Stresses on an oblique section of a body subjected to 4 Marks • Direct stresses on one plane. • Direct stresses on mutually perpendicular planes. • Direct and Shear stress on one plane. • Direct and Shear stress on mutually • Perpendicular plane (No derivations). • Mohr's circle method for finding principle stresses and planes (only simple numericals). 2.2 Thin Cylindrical shell 4 Marks • Stresses in thin closed cylindrical vessels subjected to internal pressure, Hoop stress, Radial & Axial Stress.(Simple numericals only)	05	08
3. Bending Moment & Shear Force	08	16

Specific Objectives. > Understand & analyse the basic principles involved in the behaviour of		
machine parts under load in the context of designing it		
Contents		
3.1 Concept & definition of Shear force & bending moment		
• Relation between rate of loading, shear force & bending moment.		
• Shear force & bending moment diagrams for cantilevers, simply		
supported beam & over hanging beam subjected to point loads &		
uniformly distributed load. Location of point of contra flexure 4. Moment of Inertia		
Specific Objectives.		
 Determine Area Moment of Inertia of regular and composite sections. 		
Contents		
• 4.1 Concept & definition of Moment of inertia, Parallel & perpendicular		
axes theorem.		
• (No derivation)	06	16
Moment of inertia of solid sections-square, rectangular, circular,		
semicircular, Triangular Hollow sections- square, rectangular &		
circular cross sections only.		
Moment of Inertia of angle section, Channel section, Tee- section, I -		
section about centroidal axis & any other axis parallel to centroidal		
axis.		
Polar moment of inertia. 7 Polar moment of inertia.		
5. Bending Stresses		
Specific Objectives.		
Acquire and apply knowledge of bending stresses & shear stresses		
Contents 5.1 Theory of simple bending,		
Assumptions in the theory of bending, moment of resistance, section		
modulus, neutral axis. Stress distribution diagram for Cantilever &	06	12
simply supported beam. Equation of bending (Simple numericals based	00	12
on formula) 6 marks		
5.2 Concept of direct & transverse shear stress.		
Transverse Shear stress equation (No derivation).		
Shear stress distribution diagrams Average shear stress & Maximum		
shear stress for rectangular & circular section 6 marks		
6. Direct and Bending Stresses		
Specific Objectives.		
Acquire and apply knowledge of bending stresses and direct		
stresses.		
Contents		
6.1 Concept of Axial load, eccentric load, direct stresses, bending stresses,	07	16
maximum & minimum stresses.		
Stress distribution diagram 4 marks		
Problems on the above concepts for strut, machine parts such as offset links,		
C-clamp, Bench vice, Drilling machine frame etc 8 marks		
Condition for no tension in the section, core of section 4 marks		
7. Torsion 16 Marks		
Specific Objectives.	06	16
Understand and apply the concept of pure torsion and stresses due to	00	10
Power Transmission		

Contents		
7.1 Concept of Pure Torsion,		
 Assumptions in theory of pure Torsion, Torsion equation for solid and 		
hollow circular shafts, stress distribution across solid circular shaft.(No		
derivation)		
• Power transmitted by a shaft10 marks		
7.2 Comparison between Solid and Hollow Shafts subjected to pure torsion (no		
problem on composite and non homogeneous shaft) 6 marks		
Total	48	100

Practicals:

Skills to be developed:

Intellectual Skills:-

- 1. Identify different stresses in machine parts.
- 2. Interpret the test results.
- 3. Test different metals & compare experimental results.
- 4. Calculate the shear force & bending moment.

Motor Skills:-

- 1. Use of instruments and equipments.
- 2. Sketching of standard specimen.
- 3. Prepare machines for tests.
- 4. Observe & compare behaviour of different materials during test.
- 5. Draw shear force & bending moment diagram for different types of loading on beams.

Practicals:

- 1. Know your laboratory to understand the difference Machines / their components and purpose.
- 2. Understand different components, their purpose and operations of "Universal Testing Machines" by conducting a trial on sample test specimen.
- 3. Understand different components, their purpose and operations of Extensometer by conducting a trial on sample test specimen.
- 4. Tension test on mild steel and aluminum specimen by using Universal Testing Machine (UTM) to calculate yield stress, ultimate stress, breaking stress, percentage elongation and moduli of Elasticity.
- 5. Compression test on cast iron specimen by using "Universal Testing Machine".
- 6. Determine the shear strength of mild steel bar in single and double shear by using "Universal Testing Machine"
- 7. Determine the Brinell hardness number of mild steel specimen and also its equivalent by the other method.
- 8. Izod or charpy test on M.S., copper, aluminum and brass specimen to calculate energy absorbed.

- 9. Conduct torsion test on mild steel bar and find breaking torsional shear strength and stiffness.
- 10. To calculate and draw the S. F. D. and B. M. D. for cantilever, simply supported and overhang beams.
- 11. To determine principal stresses and to locate principal planes for a given loading by analytical and graphical (Mohr's circle) methods.

Note - Use relevant IS codes for conducting the tests.

List of Assignments:

- 1. Problems on Shear force & bending moment diagram to be drawn on graph paper. (Minimum four)
- 2. Problems on principal plane and principal stresses by Mohr's circle method. (Minimum four)

Learning Resources:

1. Books:

Sr. No.	Title	Author	Edition	Publisher
01.	Strength of material	R.S.Khurmi	Reprint 2005	S.Chand Company Ltd. Delhi
02.	Fundamentals of Strength of Materials	Debabrata Nag & Abhijit Chanda	Reprint 2011	Wiley India
03.	Strength of Materials	S.S. Ratan	Second Edition 2008,Reprint 2011	Tata McGraw Hill New Delhi
04.	Strength of Materials	R. Subramanian	Second Edition 2010	Oxford University Press
05.	Strength of Material	S Ramamrutham & R. Narayanan	6 th Edition	Dhanpat Rai & Publication New Delhi
06.	Strength of Material	S. S. Bhavikatti	Third edition	Vikas publishing House Pvt. Ltd

2. ISO, IS, BS Codes:

I S:1982(PART –I),

I S:5242-1979,

IS:1500-1983,

IS:1598-1977,

IS:1757-1973,

I S:1717,

I S:800,

Course Name: Mechanical Engineering Group

Course Code: AE/ME/MH/MI/PG/PT

Semester: Third

Subject Title: Mechanical Engineering Drawing

Subject Code: 17305

Teaching and Examination Scheme:

Teac	ching Sch	neme	Examination Scheme					
TH	TU	PR	PAPER HRS	TH	PR	OR	TW	TOTAL
03		04	04	100		25#	50@	175

NOTE:

- > Two tests each of 25 marks to be conducted as per the schedule given by MSBTE.
- > Total of tests marks for all theory subjects are to be converted out of 50 and to be entered in mark sheet under the head Sessional Work. (SW)
- > Students should use two separate A3 size sketchbooks, one for class work and another for assignment.
- > Students should solve assignment on each topic.
- > Use half imperial size drawing sheet for term work.

Rationale:

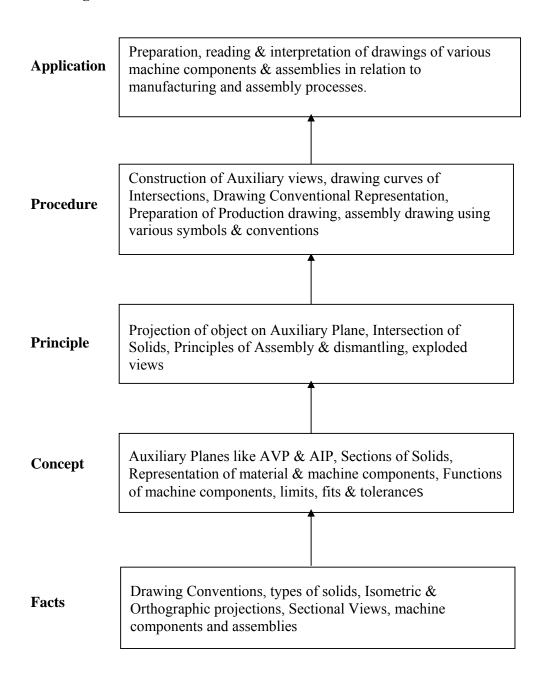
A Mechanical Engineer, irrespective of their field of operation in an industry, is expected to possess a thorough understanding of drawing, which includes clear visualization of objects and the proficiency in reading and interpreting a wide variety of production drawings. Besides, they are also expected to possess certain degree of drafting skills depending upon job function, to perform day to day activity i.e. communicating and discussing ideas with supervisors and passing on instructions to subordinates unambiguously. This course envisages reinforcing and enhancing the knowledge and skill acquired in the earlier two courses viz. Engineering Graphics & Engineering Drawing.

Objectives:

The student will be able to –

- 1. Interpret simple industrial drawings.
- 2. Interpret instructions related to manufacturing of components.
- 3. Use IS convention of representing various machine components.
- 4. Appreciate the significance & use of tolerances of size, forms & positions.

Learning Structure:



Theory:

Topics and Contents	Hours	Marks
1. Auxiliary views: -		
Specific Objectives		
➤ Understand and draw the projection of objects on auxiliary planes	06	08
1.1 Study of auxiliary planes, Projection of objects on auxiliary planes.		00
Completing the regular views with the help of given auxiliary views (Use		
first angle method of projection)	ļ	
2. Intersection of solids:-		
Specific Objectives		
 Visualize and draw Curves of intersection of the surfaces of different solids 		
Curves of intersection of the surfaces of the solids in the following cases		
2.1 Prism with prism, Cylinder with cylinder, Prism with Cylinder When (i) the	10	16
axes are at 90° and intersecting (ii) The axes are at 90° and Offset		
2.2 Cylinder with Cone		
When axis of cylinder is parallel to both the reference planes and cone	ļ	
resting on base on HP and with axis intersecting and offset from axis of		
cylinder	ļ	
3. Conventional Representation:-		
Specific Objectives	ļ	
> Understand and draw the projection of Conventional Representation		
3.1. Standard convention using SP – 46 (1988)		
3.2 Materials- C.I., M.S, Brass, Bronze, Aluminium, wood, Glass, Concrete and	ļ	
Rubber	ļ	
3.3 Long and short break in pipe, rod and shaft.	06	12
3.4Ball and Roller bearing, pipe joints, cocks, valves, internal / external threads.	00	12
3.5 Various sections- Half, removed, revolved, offset, partial and aligned sections.		
3.6 Knurling, serrated shafts, splined shafts, and keys and key ways		
3.7 Springs with square and flat ends, Gears, sprocket wheel, chain wheels		
3.8 Countersunk & counter bored holes.	ļ	
3.9 Tapers		
4. Production Drawings	ļ	
Specific Objectives		
Understand attributes of Production Drawing and Process Sheet of		
various components		
➤ Interpret various symbols shown on the drawing and selection of		
manufacturing processes accordingly		
4.1 Limits, fits and tolerances 4 marks		
Definitions, Introduction to ISO system of tolerencing- unilateral and	0.5	
bilateral and its representation on drawing, dimensional tolerances, elements	06	16
of interchangeable system, hole & shaft base systems, tolerance diagram,		
Selection of fit (clearance, transition and interference) for engineering		
applications.		
4.2 Geometrical tolerances 4 marks		
Definitions, Tolerances of form and position and its geometric		
representation-tolerance frame, datum feature, magnitude of tolerance and		
symbol, interpretation of a given symbol on drawing, simple examples.		
4.3 General welding symbols 4 marks		

Symbolic representation in Engineering practices and its interpretation. 4.4 Characteristics of surface roughness 4 marks Indication of machining symbol showing direction of lay, roughness grades, machining allowances, manufacturing methods, using ISO code. Relation of surface roughness values with manufacturing processes.		
5. Details to Assembly drawing Specific Objectives ➤ Visualize and draw Details to Assembly ➤ Understand the procedure for assembly of components i. Introduction- Basic principles of process of assembly.		
ii. Couplings – Universal couplings & Oldham's Coupling iii. Bearing – Foot Step Bearing & Pedestal Bearing iv. Tool Post – Lathe (Including Square tool post), shaper v. Machine vice & Pipe Vice	10	24
vi. Screw Jack vii. Valves- Steam Stop Valve, Non – Return Valve viii. IC engine components assembly 6. Assembly to Details		
OSpecific Objectives Visualize and draw Details from Assembly drawing Understand the sequence of dismantling the assembly into components		
 i. Introduction – basic principles of dismantling process ii. Pedestal Bearing iii. Lathe Tail Stock iv. Drilling Jig 	10	24
v. Piston & connecting rod assembly, clutch, shoe brake vi. Cross head and Stuffing box Assembly vii. Hydraulic, pneumatic Valves (Not containing more than eight parts) viii. Fast & loose pulley		
TOTAL	48	100

Note: - For topic no. 5 and 6 any other assembly containing at least 6 to 10 components may be considered.

Skills to be developed for Practical:

Intellectual Skills:

- To interpret the projection of objects on auxiliary planes
- Understand interpenetration of solids.
- Interpret Conventional symbols as per IS code SP46.
- Interpret limits, fits and tolerances on a given drawing.
- Understand Production drawing of m/c components
- Identify various components in a given assembly and find the sequence of dismantling it
- Visualize details of components and determine the sequence of components assembly.

Motor Skills:

• To draw the projection of objects in auxiliary planes

- Draw front view and top view of solids Penetrating one with other and find the shape of the interpenetration curve.
- Assign and draw surface roughness values and symbols on a part drawing.
- Conventionally represent limit, fits and tolerances on a given drawing as per the functional requirements of components.
- To draw the production drawing of m/c components.
- Prepare bill of materials in assembly drawing.
- To dismantle machine and prepare production drawing of various components of assembly.

List of Practical:	
1.Auxiliary views	4 hours
➤ One sheet containing minimum two problems	
2. Intersections of Solids	8 hours
One Sheet containing at least three problems.	
3. Conventional Representation	12 hours
➤ Conventional Representation of machine components as per SP – 46 (1988)) - one sheet
Limit, Fit, Tolerances, geometric tolerances, Machining Symbols, welding	symbols
– one sheet	
4. Production Drawing of at least one component- one sheet.	6hours
5. Assembly to details drawing	14 hours
Draw the given assembly and prepare component drawings, including convergence	
representation, tolerances and surface finish symbols. Prepare part list conta	nined, name of
components, quantity, material specifications and remarks - One sheet	
6. Details to Assembly drawing	14 hours
From a given drawings of components prepare an assembly with two views	
containing name of component, quantity, material specifications and remark	ks, show overall
dimensions of the assembly	
7. Two problems on assembly drawings using any CAD Package and print it.	14 hours
Students will prepare a drawing discuss in 5 & 6. (Assembly containing maximu	m 6 to 7
components)	
8. Dismantle any machine assembly having 6 to 10 part. Prepare the sketches in sketches	
dimension and then draw assembly6	hours

List of Assignments:

- 1. Auxiliary views: At least two problems
- 2. Intersections of Solids: At least four problems
- 3. Assembly to details drawing: At least one problem
- 4. Details to Assembly drawing: Solve at least two problems.

Note: Above assignment is the part of term work.

Learning Resources:

Books:

Sr. No.	Author	Title	Publication & Edition
1	N.D.Bhatt	Machine Drawing	Charotar Publication, Anand, Reprint 2010

2	L. K. Narayanan, P. Kannaich, K. VenkatReddy	Production Drawing	New Age International Publication, 2010
3	N Sidheswar P Kannaiah V V S Sastry	Machine Drawing	Tata McGraw Hill Education Pvt. Ltd., 2010
4	N. D.Junnarkar	Machine Drawing	Pearson, Third Impression 2011
5	Goutam Pohit Goutam Ghosh	Machine Drawing with AutoCAD	Pearson, Reprint 2009
6	Basudeb Bhattacharyya	Machine Drawing	Oxford, 2011
7	IS Code SP 46 (1988)	Code of practice for general engineering drawing.	Engineering Drawing Practice for School and colleges, 2005

w.e.f Academic Year 2012-13

Course Name: Mechanical Engineering Group

Course Code: AE/ME/PG/PT/MH/MI/FE

Semester: Third

Subject Title: Computer Aided Drafting

Subject Code: 17016

Teaching and Examination Scheme

Teaching Scheme			Examination Scheme					
TH	TU	PR	PAPER HRS	TH	PR	OR	TW	TOTAL
01		04			50#		25@	75

Rationale:

Now a day a manual drafting is obsolete in industry. Computers being the inevitable part in an engineer's life due to its inbuilt characteristics which helps him to do various task with acceleration. Using computers and CAD software it is easy to create and modify drawings ultimately it saves time. It also may be useful to generate assembly and manufacturing drawings.

In mechanical industry operating skills are required for computer aided drafting operations of machine components, handling of printers & plotters. This subject is also useful to apply concepts in 3 D modeling.

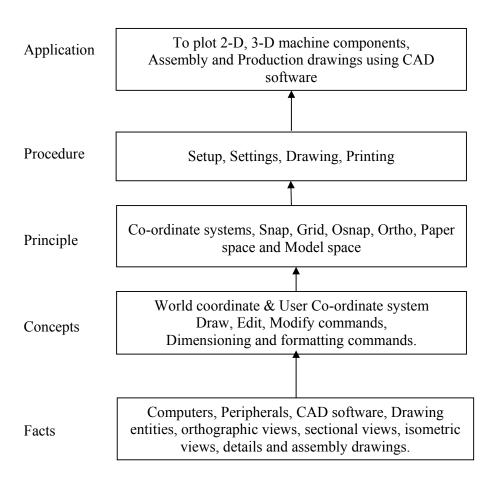
General Objectives:

Students will be able to

- 1) Draw, edit and modify 2D drawings.
- 2) Give dimensions, tolerances and geometrical tolerances.
- 3) Draw Isometric drawing and 3 D drawing.
- 4) Plot a drawing.

'G' Scheme

Learning Structure:



Theory:

Topic and Content	Hours
1: Introduction to Computer Aided Drafting 02 Hours	
Specific Objectives:	
Understand and use basics of CAD systems.	
Content:	
1.1 Introduction to Computer Aided Drafting (CAD)- Applications, Various	02
Softwares for Computer Aided Drafting	02
1.2 Co-ordinate system- Cartesian & Polar-Absolute, Relative mode.	
1.3 CAD initial settings commands - Snap, grid, ortho, osnap, limits, units, filters,	
itscale, mbuttonpan	
1.4 Object Selection methods – picking, window, crossing, fence, last, previous etc.	
2: Zoom and formatting Commands 02 Hours	
Specific Objectives:	
View drawing.	
Format drawing entities.	02
Content:	
2.1 Zoom Commands – all, previous, out, in, extent, realtime, dynamic, window, pan.	
2.2 Formatting commands - Layers, block, linetype, lineweight, color.	
3: Draw and Enquiry commands 02 Hours	
Specific Objectives:	
> Draw 2 D drawings	
➤ Measure length and area	
9	02
Content:	
3.1 Draw Command - Line, arc, circle, rectangle, polygon, ellipse, spline, block,	
hatch	
3.2 Enquiry commands - distance, area	
4: Edit and Modify commands 03 Hours	
Specific Objectives:	
Rectify 2 D drawings.	
➤ Modify 2 D drawings	
Content:	03
4.1 Modify Command - Erase, oops, break, trim, copy, move, mirror, offset, fillet,	
chamfer, array, extend, rotate, scale, lengthen, stretch, measure, divide, explode,	
align.	
4.2 Grips editing- Move, Copy, Stretch.	
5: Dimensioning, Text and Plot Commands 03Hours	·
Specific Objectives:	
> Apply dimensions.	
Write text or remarks.	
Plot a drawing.	ı
-	03
Content: 5.1 Dimensioning commands Dimension styles Dimensional Telegrapes and	
5.1 Dimensioning commands - Dimension styles, Dimensional Tolerances and	
Geometrical Tolerances. 5.2 Text commands drawt mtout command	
5.2 Text commands - dtext, mtext command.	
5.3 Plotting a drawing - paper space, model space, creating table, plot commands.	r
6: Isometric and 3D Drawings 04 Hours	0.4
Specific Objectives:	04
Draw and modify 3 D drawings.	

- Find materials mass property.
- > Draw isometric drawings.

Content:

- **6.1 3D Edit Commands** -Pline, 3Dpoly, pedit, join splinedit commands.
- **6.2 View Commands** View ports, UCS, WCS commands
- **6.3 3D Object and 3D operations** 3 D Object Cube, Cylinder, Cone, Sphere, Wedge. 3 D operations extrude, revolve, 3Dmirror, 3Dmove, 3Dpan, 3Drotate, 3Darray, slice, sweep. Boolean operations union, subtract, intersection. Using Isometric style option of snap command draw isometric drawing
- **6.4 Shade and Enquiry commands** mass property, Shade and render command.

Total 16

Note: Multimedia projection facility shall be used during lecture sessions along with computer facility e.g. laptop, computer, LCD projector.

Skills to be developed:

Intellectual skills:

- 1) Select and develop coordinate system.
- 2) Interpret a drawing to draw in CAD software.
- 3) Select & use appropriate CAD commands for given situation.

Motor Skills:

- 1) Use pull down menu and their submenu, toolbars
- 2) Setting the initial drawing setup.
- 3) Draw, edit and modify drawings.
- 4) Use printers and plotters for plotting production drawings.

Practical:

List of Practical's:

- 1. Set the initial view.
- 2. Use of Draw command.
- 3. Use of Edit command.
- 4. Use of Modify command.
- 5. Apply dimensions.
- 6. Draw Isometric drawing.
- 7. Draw 3 D drawings.
- 8. Plotting of drawings on A2/A3 size sheet.

Guideline for Practical: One student per computer terminal.

Note: Use of any one Computer Aided Drafting Software of Latest Version is recommended.

Practical Examination: (2 Hours for each student)

Creation of 2 D / 3D / Isometric drawings for the given part or drawing, followed by oral examination based on above term work.

(One computer terminal per each student)

Learning Resources:

1. Books:

Sr. No.	Author	Title	Publisher / Edition
1	Sham Tickoo	Autocad: A Problem-Solving Approach	Thomson Learning EMEA, Limited
2	George Omura	Mastering Auto CAD	BPB Publication
3	George Omura	ABC's of Auto CAD	BPB Publication
4	Gautam Purohit & Gautam Ghosh	M/c Drawing with AutoCad	Pearson Publication
5	T Jeyapoovan	Engineering Graphics Using AutoCAD	Vikas Publishing House Pvt. Ltd. Fifth Edition
6		Various software manuals	

2. CDs, PPTs.:

- 1. Beginners AutoCAD 2011 Tutorial DVD, Advanced AutoCAD 2011 Tutorial DVD, 2
- 2. Learning AutoCAD 2012 Tutorial DVD Publisher Infinite Skills Inc. Email: directsales@infiniteskills.com
- 3. EKHO Institute presents Professional AutoCAD Training Videos
- 4. Learning AutoCAD 2012 Tutorial DVD Video Training by Infinite Skills.

3. Websites:

http://www.we-r-here.com/cad/tutorials/index.htm

http://www.cadtutor.net/tutorials/autocad/

http://www.caddprimer.com/AutoCAD training tutorial/AutoCAD training lessons.htm

http://www.autocadmark.com/

http://www.autocadtutorials.net/

Equipment List:

- 1) Latest Configuration Computers which can be able to run latest any Computer Aided Drafting Software. (At least One Computer per student in practical session.)
- 2) Any latest Authorised Computer Aided Drafting Software (20 seats).
- 3) Plotter of size A2/A3
- 4) LCD Projector

w.e.f Academic Year 2012-13 'G' Scheme

Course Name: Mechanical Engineering Group

Course Code: AE/ME/PG/PT/MH/MI

Semester: Third

Subject Title : Professional Practices-I

Subject Code: 17017

Teaching and Examination Scheme:

Teaching Scheme			Examination Scheme					
TH	TU	PR	PAPER HRS	TH	PR	OR	TW	TOTAL
		03					50@	50

Rationale:

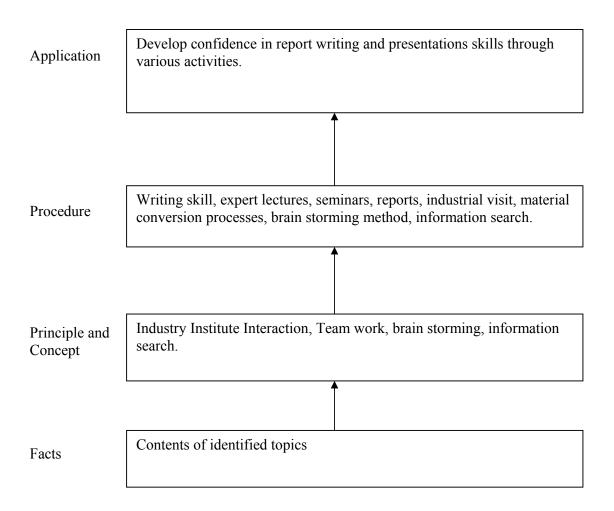
The purpose of introducing Professional practices is to fulfill the need of students to stand in today's global market with knowledge and confidence. Practical aspects of engineering can be learned through industrial visits, industry expert lectures, seminars, searching alternative solutions and validation of the selected alternatives. Subject like professional practices allow the students to think independently using integrated knowledge of various subjects and give opportunity of working with their own hands. The exercises included in this subject are useful to create social awareness and developing them into good citizens of tomorrow.

General Objectives

Student will be able to:

- 1. Acquire information from different sources.
- 2. Prepare notes for given topics
- 3. Present seminar using power projection system.
- 4. Interact with peers to share thoughts.
- 5. Work in a team and develop team spirit.

Learning Structure:



Intellectual skill:

Student will be able to-

- 1) Search information from various resources.
- 2) Prepare notes on selected topics.
- 3) Participate in group discussions.

Motor Skills:

- 1) Observe industrial practices during visits.
- 2) Prepare slides / charts for presentation in seminar.

Content:

	Topic & Content	Hours
1. Inform	ation search:	
workshops 3 to 4 stud	nation search be made through manufacturers catalogues, suppliers, traders, s, journals & websites etc. and submit a report on any two topics in a group of lents. Following topics are suggested. Any other equivalent topic can also be	
selected. F	Report size shall be around $7 - 10$ pages.	
i)	Any one type of valve. Dismantle the valve and prepare part list with quantity material specifications, measure the dimensions of component & prepare the detailed drawings of all components specifying dimensional & geometric tolerances for important surfaces giving machining symbols. OR	
i)	Draw the assembly in working position showing sectional elevation & plan views with overall dimensions.	
ii)	List the types of A/c motors commonly used for various industrial applications write specifications of any two motors and show their performance characteristics using manufacturers catalogue.	06
iii)	List 10 materials (Ferrous & nonferrous metals & alloys and non metals) Give their specifications, state their important properties & its applications.	
iv)	List the components in a transmission system of 2 wheeler & 4 wheeler automobiles and explain their functions in detail identify their materials.	
v)	Non destructive testing – methods & applications (minimum 3 methods)	
vi)	IS codes related to impact test, hardness test, bend test of steels.	
vii)	Collection of information of domestic electric heating appliances like hot water boiler, electric iron, electric cooker, microwave oven, toaster etc. Describe their working principles, controls & safety features.	
viii)	Heat treatment processes for steels – purpose, modified properties & applications.	
ix)	Advances in material technology – smart materials, shape memory alloys,	
,	Nano materials.	
	es by professionals / industry experts	
	res of 2 hour duration are arranged on any two topics suggested below or any	
	able topics so that the students get oriented to the industrial environment &	
	Students are required to prepare a brief report of each lecture as a part of their	
term work		06
	Organizational structure, various functional departments & their inter relations, ypes of products manufactured or services provided.	06
	Role of diploma engineers (Mech, Auto, Prod,) in an organization,	
	esponsibilities to be taken and future scope.	
	Vork culture	
	ndustrial growth in India and new opportunities & avenues available to	

diploma engineers. v) Time management vi) Developing product quality & reliability vii) Creative & innovative thinking approach viii) Personality Development ix) Interview technique / group discussion technique x) E – banking – credit card, debit card, ATM operation 3. Group Discussion – One exercise Group discussions on any one of the following topics are suggested or any other general / social /educational / technology related topics. Group size - divide practical batch into groups of 7 to 10 students, time for group discussion 15 to 20 minutes. Current topics from news papers / T.V. news related to social, education & technology Energy crisis in India ii) Lokpal Vidheyak (Act) iii) iv) Corruption prevention v) Reservation policy Policies at institutional level – dress code, campus discipline & cleanliness 04 vi) vii) Ban on plastic carry bags. viii) Pollution control ix) Population control Brain drain x) xi) Diploma (Mechanical Engineering group) opting for Computer and Information Technology jobs. xii) Right to information act xiii) Anti-Ragging act. Students should prepare a report on salient points discussed on the topic & summarize concluding remarks. 4. Seminar Seminar on any one topic specified in the list given below or any topic suggested under information search & expert lecture. Time for presentation -10 minutes per group of 2 to 3 students, Prepare power point presentation and submit seminar notes not more than 10 pages mentioning source of information – books, magazines, journals, websites, surveys, etc. Topics – i) Fasteners & its industrial applications Powder metallurgy technique ii) iii) Non-destructive testing 08 Couplings – types & applications iv) Bearings - types & applications v) Accident prevention & safely measures vi) vii) Fuel injection systems viii) Modern features of automobiles Welding technology ix) Selection of electric motors x) Industrial drives- Types, advantages and limitations, Applications xi) xii) ISO system of limit, fits & tolerances xiii) Type of screw threads & their applications.

5 Industrial Visits				
5. Industrial Visits				
Structured industrial visits are arranged and report of the same be submitted by the				
individual student to form a part of the term work.				
No of visits – at least two				
Scale of industry – Small scale unit, medium scale unit				
Group size – practical batch containing not more than 20-25 students,				
Report 2 to 5 pages.				
Purpose –				
a. Get familiar with industry environment				
b. Know the organizational structure				
c. Working of functional departments & their inter relation				
d. Products manufactured, services provided	08			
e. Identification of materials used and material flow from raw	08			
materials to finished products				
f. Study the production processes & types of machines used				
g. Layout of machinery & equipments in general				
h. List of material handling equipment				
Following types of industries may be visited or any industrial units existing in the				
area or nearby areas.				
i) Manufacturing units				
ii) Chemical Process industry/cotton/grain processing industry/dairy etc.				
iii) Service stations - Auto repairs work shop / garage, farm implements.				
iv) ST workshop / city transport workshops.				
6. Individual Assignments				
Any two assignments from the list suggested based on the subjects in the 3 rd semester				
(Any other suitable assignments may be chosen)				
i) Material selection, specifications & properties desirable of 10 different				
machine components.				
ii) Select 5 different plain carbon steels & alloy steels used for manufacturing				
machine components & specify heat treatment processes to improve material				
properties, give brief description of one of the heat treatment processes.				
iii) List the various properties & applications of following materials.				
a) Thermo plastic plastics b) Thermo setting plastics c) Rubber d) Ceramics				
iv) Any two problems on bending moment diagram, shear force diagram,				
deflection of beams & torsion topics of strength of materials.	10			
v) Any two problems from applied mathematics				
a) Problems on area under the curve & volume of revolution				
b) Problems on applications of differential equations				
v) Any two problems on finding principal stresses by using Mohr's circle,				
finding magnitude & position of maximum shear stresses.				
vi) Prepare a questionnaire for conducting interview of a successful entrepreneur				
& conduct the interview.				
vii) List 5 different engineering applications of transformers stating the types, &				
specifications, write the working principle of auto transformer.				
viii) Draw the electric wiring diagram for a) staircase b) water pump-motor set.				
List the electrical components used in the electric circuit.				
7. Socially Relevant activities				
Conduct any one activity through active participation of students & write the report				
Group of students – maximum 4	06			
Report – not more than 6 pages				
List of suggested activities – (Activities may be thought in terms of campus				
List of suggested activities – (Activities may be mought in terms of campus				

To	al	48
x) Traffic management within campus / city.		
ix) Rain water harvesting		
viii) Educating students / people about firefighting equipment		
vii) Awareness to avoid use of plastic carry bags		
vi) Clean campus / city		
v) Water conservation		
iv) Conservation of electrical energy		
iii) Building ethical & moral values		
ii) Literacy camps		
i) Go green movement		
improvement)		

Learning Resources:

1. Books:

Sr. No.	Author	Title	Publisher
01	NRDC, Publication Bi Monthly Journal	Invention Intelligence Journal	National Research Development Corporation, GOI.
02	DK Publishing	How things works encyclopedia	DK Publishing
03	E.H. McGratj, S.J.	Basic Managerial Skills for All Ninth Edition	PHI

2. Web sites

www.engineeringforchange.org www.wikipedia.com www.slideshare.com www.teachertube.com